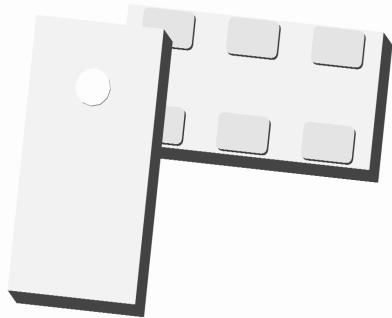


Xinger[®] IV

Ultra Small Low Profile 0603 Balu 50Ω to 50Ω Balance



Description:

The X4B40L1-5050G is an ultra-small low profile balanced to unbalanced transformer designed for differential inputs and output for 5G applications. The X4B40L1-5050G is ideal for high volume manufacturing. The X4B40L1-5050G is available on tape and reel for pick and place high volume manufacturing.

All of the Xinger components are constructed from ceramic filled PTFE composites, which possess excellent electrical and mechanical stability. All parts have been subjected to rigorous qualification testing and units are 100% RF tested. Produced in an ENIG final finish.

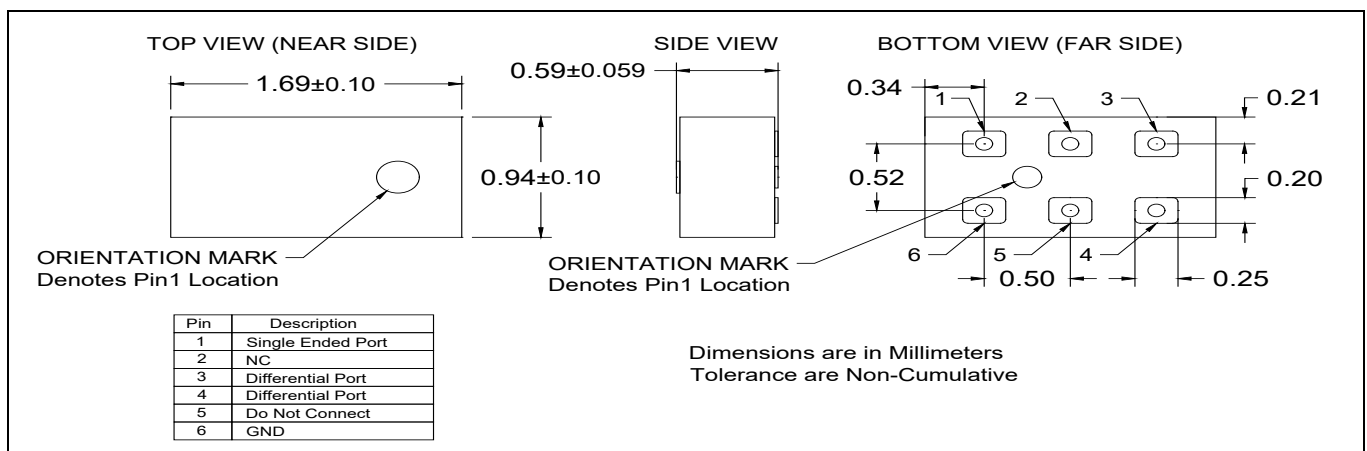
Electrical Specifications**

Features:	Frequency	Port Impedance	Insertion Loss	Return Loss	Amplitude Balance
• 2300-6000 MHz	MHz	Single	dB Max	dB Min	dB Max
• 50 Ohm to 2 x 25 Ohm		Ended:Differential			
• 5G Applications		50:50			
• Very Low Loss	2300-2500	50:50	0.6	16	±0.8
• Tight Amplitude Balance	2500-5000	50:50	0.8	16	±0.9
• Production Friendly	5000-6000	50:50	1.2	14	±2.4
• Tape and Reel					
• Non-conductive Surface		Phase Imbalance	CMRR	Power	Operating Temp
• RoHS Compliant		Degrees	dB Min	Avg. CW	°C
• Halogen Free		180±6	23	Watts@105°C	-55 to 140
		180±7	23		-55 to 140
		180±10	17		-55 to 140

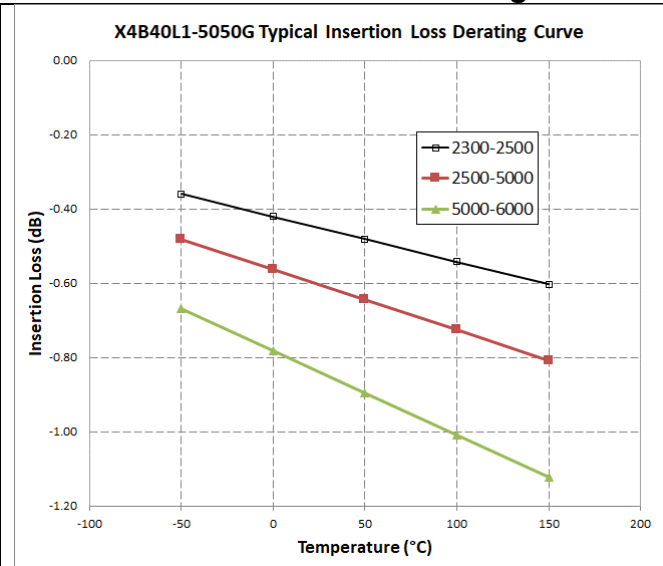
**Specification based on performance of unit properly installed on a TTM test board with small signal applied.

*Specifications subject to change without notice. Refer to parameter definitions for details.

Mechanical Outline:

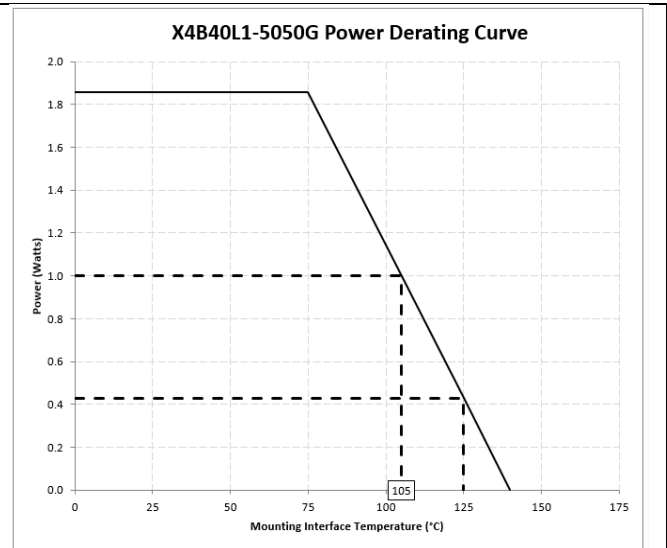


Insertion Loss and Power Derating Curves



Insertion Loss Derating

The insertion loss, at a given frequency, of a group of couplers is measured at 25°C and then averaged. The measurements are performed under small signal conditions (i.e. using a Vector Network Analyzer). The process is repeated at 105°C and 140°C. A best-fit line for the measured data is computed and then plotted from -55°C to 140°C.



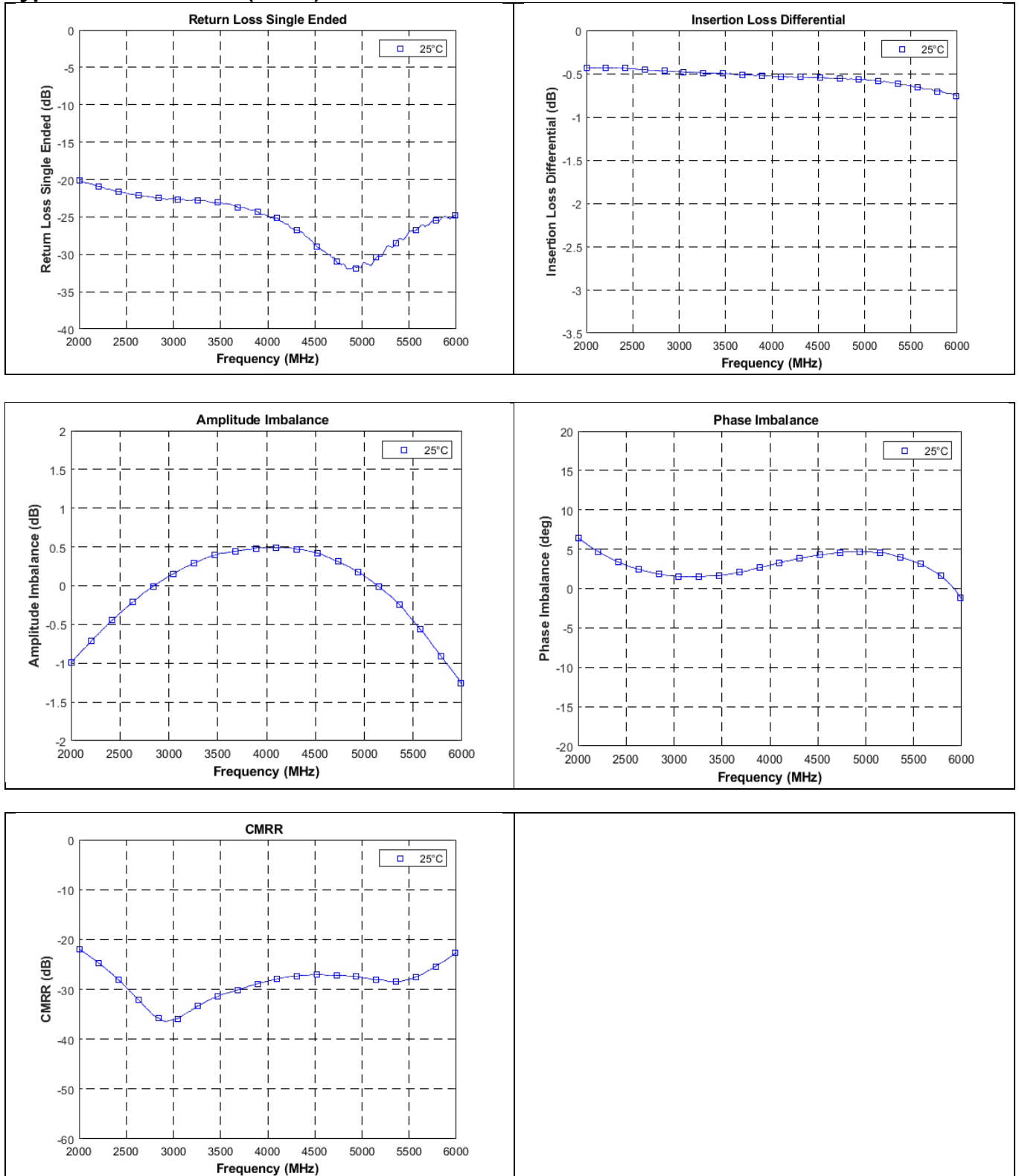
Power Derating

The power handling and corresponding power derating plots are a function of the thermal resistance, mounting surface temperature (base plate temperature), maximum continuous operating temperature of the coupler, and the thermal insertion loss. The thermal insertion loss is defined in the Power Handling section of the data sheet.

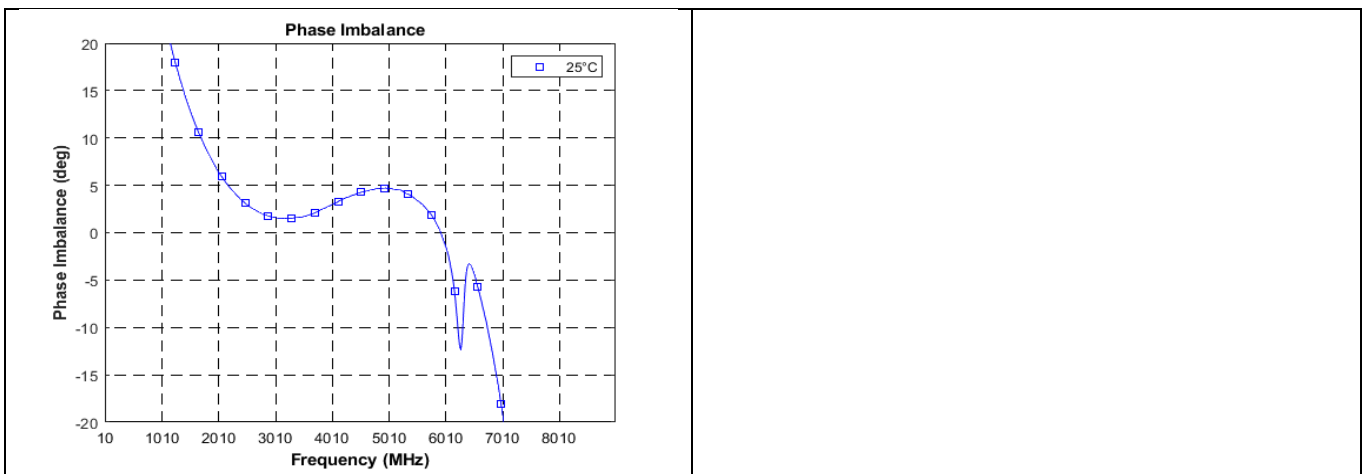
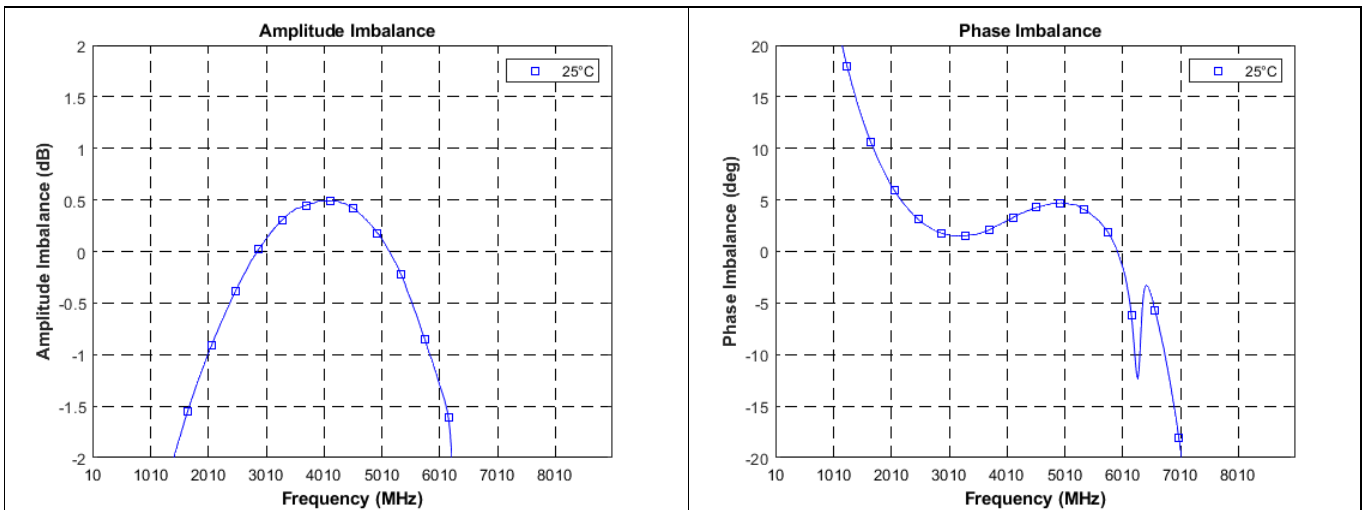
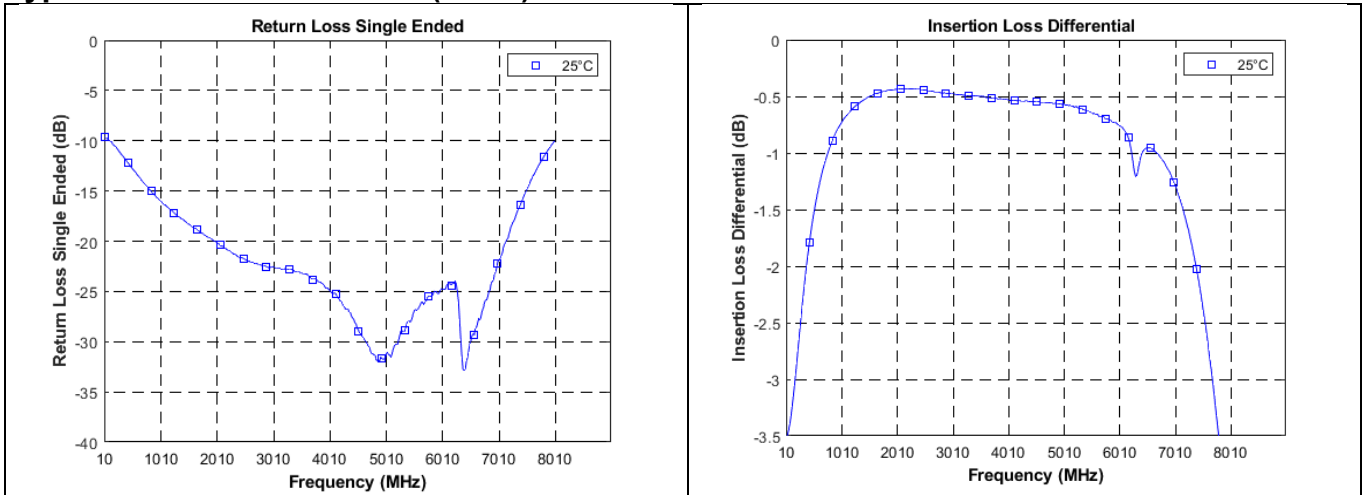
As the mounting interface temperature approaches the maximum continuous operating temperature, the power handling decreases to zero.

If mounting temperature is greater than 105°C, Xinger coupler will perform reliably as long as the input power is derated to the curve above.

Typical Performance (25 °C): 2000 MHz to 6000 MHz



Typical Broad Performance (25 °C): 10 MHz to 8010 MHz



Definition of Measured Specification

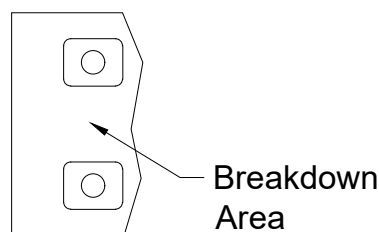
Parameter	Definition	Mathematical Representation
Return Loss	The impedance match at the single ended port.	$RL = 20Log_{10}(S_{11})$
Differential Port Return Loss	The impedance match at the differential port.	$RLD = 20Log_{10} 0.5 * (S_{22} - S_{23} - S_{32} + S_{33}) $
Insertion Loss	Power loss from common mode to differential mode.	$ILD = 20Log_{10}(0.707 * (S_{21} - S_{31}))$
Phase Imbalance	The difference in phase angle between the two differential ports, offset by 180 deg.	$PB = (Phase(S_{21}) - Phase(S_{31})) - 180^{\circ}$
Amplitude Imbalance	The ratio of the power at differential ports.	$AB = 20Log_{10} \frac{S_{21}}{S_{31}} $
Common Mode Rejection Ratio	The ratio of powers of the differential gain to the common-mode gain.	$CMRR = \pm 20Log_{10}(S_{21}+S_{31})/(S_{21}-S_{31})$

*Parts are 100% RF tested as per spec definition.

** Refer to page 6 for port assignment

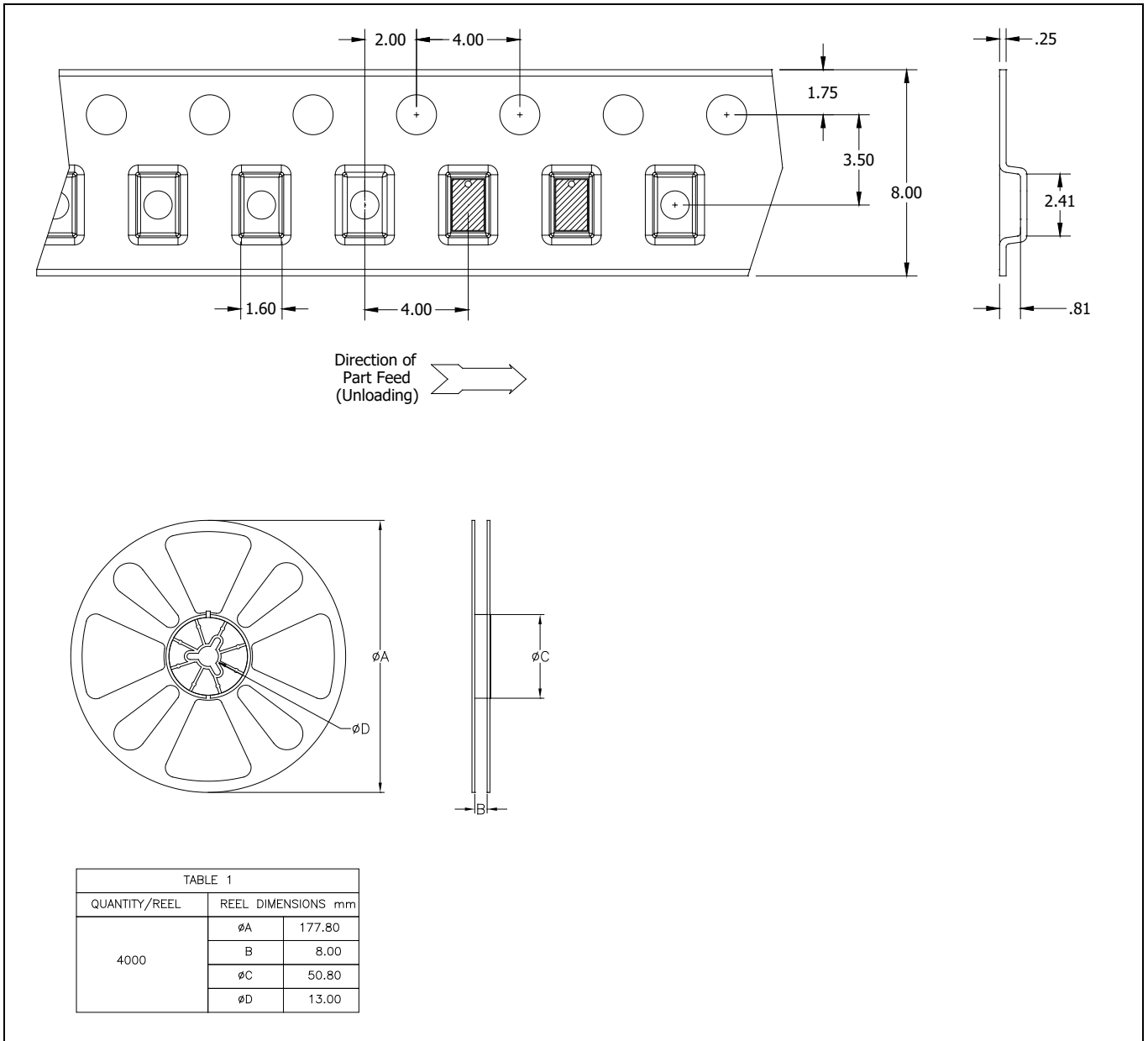
Peak Power Handling

High-Pot testing of these components during the qualification procedure resulted in a minimum breakdown voltage of 1Kv (minimum recorded value). This voltage level corresponds to a breakdown resistance capable of handling at least 12dB peaks over average power levels, for very short durations. The breakdown location consistently occurred across the pads and the ground bar (see illustration below). The breakdown levels at these points will be affected by any contamination in the gap area around these pads. These areas must be kept clean for optimum performance. It is recommended that the user test for voltage breakdown under the maximum operating conditions and over worst case modulation induced power peaking. This evaluation should also include extreme environmental conditions (such as high humidity).



Packaging and Ordering Information:

Parts are available in reel and are packaged per EIA 481-D. Parts are oriented in tape and reel as shown below. Minimum order quantities are 4000 per reel.



Contact us:
rf&s_support@ttm.com